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#### 2 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

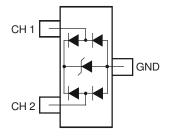
#### **Features**

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±8kV
- 2 Channels of ESD protection
- Low Channel Input Capacitance
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.009 grams (Approximate)





**Device Schematic** 

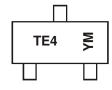
### **Ordering Information** (Note 4)

| Part Number    | Case  | Packaging         |
|----------------|-------|-------------------|
| D1213A-02SOL-7 | SOT23 | 3,000/Tape & Reel |

Notes:

- $1.\ No\ purposely\ added\ lead.\ Fully\ EU\ Directive\ 2002/95/EC\ (RoHS)\ \&\ 2011/65/EU\ (RoHS\ 2)\ compliant.$
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



TE4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

| Date Code Ney | -   |     |      |     |      |     |     |      |     |      |     |      |
|---------------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Year          | 201 | 1   | 2012 |     | 2013 | 20  | 14  | 2015 |     | 2016 | :   | 2017 |
| Code          | Υ   |     | Z    |     | Α    |     | В   | С    |     | D    |     | E    |
| Month         | Jan | Feb | Mar  | Apr | May  | Jun | Jul | Aug  | Sep | Oct  | Nov | Dec  |
| Code          | 1   | 2   | 3    | 4   | 5    | 6   | 7   | 8    | 9   | 0    | N   | D    |



### Maximum Ratings @TA = 25°C unless otherwise specified

| Characteristic                     | Symbol                   | Value | Unit | Conditions             |
|------------------------------------|--------------------------|-------|------|------------------------|
| Peak Pulse Current (Note 7)        | I <sub>PP</sub>          | 5     | Α    | 8/20 μs, Per Fig. 2    |
| ESD Protection – Contact Discharge | V <sub>ESD</sub> Contact | ±8    | kV   | Standard IEC 61000-4-2 |
| ESD Protection – Air Discharge     | V <sub>ESD Air</sub>     | ±15   | kV   | Standard IEC 61000-4-2 |

### **Thermal Characteristics**

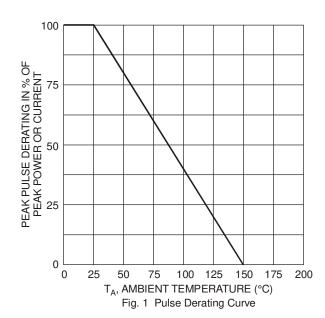
| Characteristic                                   | Symbol           | Value       | Unit |
|--|------------------|-------------|------|
| Package Power Dissipation (Note 5)               | P <sub>D</sub>   | 300         | mW   |
| Thermal Resistance, Junction to Ambient (Note 5) | $R_{	hetaJA}$    | 417         | °C/W |
| Operating Temperature Range                      | TJ               | -55 to +125 | °C   |
| Storage Temperature Range                        | T <sub>STG</sub> | -65 to +150 | °C   |

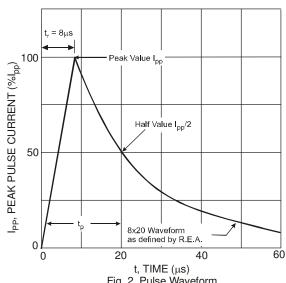
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic (Note 7)                       | Symbol           | Min | Тур  | Max  | Unit | Test Conditions                     |
|---|------------------|-----|------|------|------|-------------------------------------|
| Reverse working voltage                       | VRWM             | -   | -    | 3.3  | V    | -                                   |
| Reverse current (Note 6)                      | $I_R$            | -   | 0.1  | 1.0  | μΑ   | $V_R = V_{RWM} = 3.3V$              |
| Reverse breakdown voltage                     | $V_{BR}$         | 6.0 | 7.5  | 9.0  | V    | I <sub>R</sub> = 1mA                |
| Forward voltage                               | $V_{F}$          | 0.6 | 0.8  | 0.95 | V    | I <sub>F</sub> = 8mA                |
| Reverse clamping voltage, Positive Transients | V <sub>CL1</sub> | -   | 10.0 | -    | V    | $I_{PP} = 1A, t_p = 8/20 \mu s$     |
| Reverse clamping voltage, Negative Transients | $V_{CL2}$        | -   | -1.7 | -    | V    | $I_{PP} = -1A$ , $t_p = 8/20 \mu s$ |
| Dynamic resistance                            | R <sub>DYN</sub> | -   | 0.9  | -    | Ω    | $I_R = 1A$ , $t_p = 8/20 \mu s$     |
| Capacitance                                   | Ст               | -   | 0.85 | 1.2  | pF   | V <sub>R</sub> = 1.65V, f = 1MHz    |

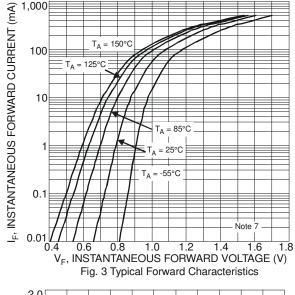
Notes:

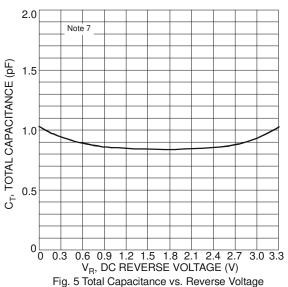
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
  6. Short duration pulse test used to minimize self-heating effect.
- 7. Measured between any channel and GND

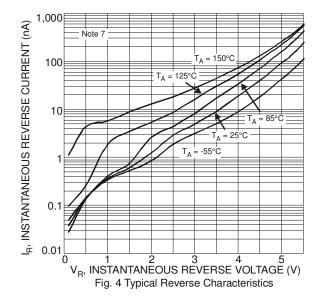




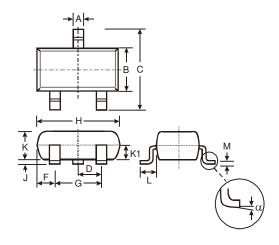








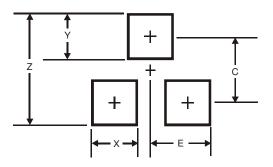
## **Package Outline Dimensions**



| SOT23 |                      |      |       |  |  |  |  |
|-------|----------------------|------|-------|--|--|--|--|
| Dim   | Min                  | Max  | Тур   |  |  |  |  |
| Α     | 0.37                 | 0.51 | 0.40  |  |  |  |  |
| В     | 1.20                 | 1.40 | 1.30  |  |  |  |  |
| С     | 2.30                 | 2.50 | 2.40  |  |  |  |  |
| D     | 0.89                 | 1.03 | 0.915 |  |  |  |  |
| F     | 0.45                 | 0.60 | 0.535 |  |  |  |  |
| G     | 1.78                 | 2.05 | 1.83  |  |  |  |  |
| Н     | 2.80                 | 3.00 | 2.90  |  |  |  |  |
| 7     | 0.013                | 0.10 | 0.05  |  |  |  |  |
| K     | 0.903                | 1.10 | 1.00  |  |  |  |  |
| K1    | -                    | -    | 0.400 |  |  |  |  |
| L     | 0.45                 | 0.61 | 0.55  |  |  |  |  |
| M     | 0.085                | 0.18 | 0.11  |  |  |  |  |
| α     | 0°                   | 8°   | -     |  |  |  |  |
| All   | All Dimensions in mm |      |       |  |  |  |  |



### **Suggested Pad Layout**



| Dimensions | Value (in mm) |  |  |  |
|------------|---------------|--|--|--|
| Z          | 2.9           |  |  |  |
| Х          | 0.8           |  |  |  |
| Υ          | 0.9           |  |  |  |
| С          | 2.0           |  |  |  |
| E          | 1.35          |  |  |  |

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